

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3640507

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	CHANG OON KIM	10/25/2015
RECEIVING PARTY DATA		
Name:	DONGBU HITEK CO., LTD.	
Street Address:	90, SUDO-RO, WONMI-GU	
Internal Address:	GYEONGGI-DO	
City:	BUCHEON-SI	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	420-712	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14957384
CORRESPONDENCE DATA		
Fax Number:	(559)840-0856	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	559-840-0841	
Email:	drewfortney@cencalip.com	
Correspondent Name:	CENTRAL CALIFORNIA IP GROUP, P.C.	
Address Line 1:	410 W. FALLBROOK AVE., SUITE 211	
Address Line 4:	FRESNO, CALIFORNIA 93711	
ATTORNEY DOCKET NUMBER:	OPP-GZ-2015-0007-US-00	
NAME OF SUBMITTER:	ANDREW D. FORTNEY, PH.D., REG. NO. 34600	
SIGNATURE:	/Andrew D. Fortney/	
DATE SIGNED:	12/02/2015	
Total Attachments: 1		
source=OPP-GZ-2015-0007-US-00_Assignment_20151202_#page1.tif		

김창온 (KIM CHANGWON)/20191123162944

Attorney Docket No.: OPP-GZ-2015-0007-US-00

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

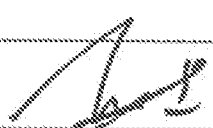
Chang Oon KIM

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

DISPLAY APPARATUSDo hereby sell, assign and transfer to **Dongbu HiTek Co., Ltd.**, a corporation of **the Republic of Korea**, having a place of business at **90, Sudo-ro, Wuxmi-gu, Busheon-si, Gyeonggi-do 430-712, Republic of Korea**, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;Agree that **Dongbu HiTek Co., Ltd.**, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title in said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below.

Full Name of Sole/First Inventor: Chang Oon KIM	
Inventor's Signature: 	Date: Month/Day/Year 10/25/2015

Full Name of Second Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year